

Low Noise CATV Amplifier 50 - 1000 MHz

Rev. V3

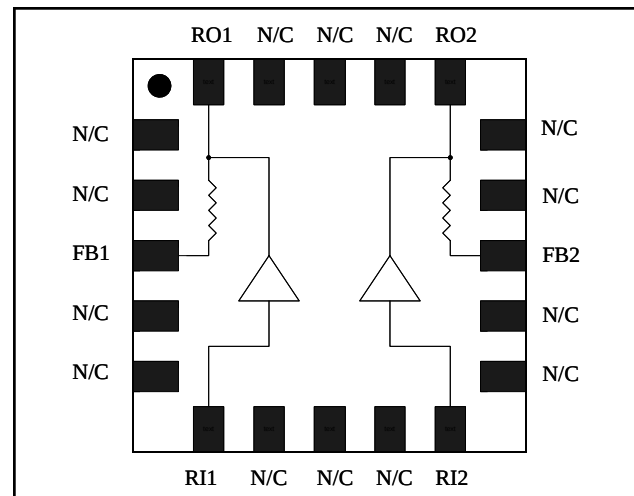
Features

- Low Distortion
- Low Noise Figure
- Push Pull Design
- Single Positive Supply
- 4 mm 20-Lead PQFN Package

Description

M/A-COM's MAAMSS0003 is a GaAs PHEMT MMIC amplifier in a 4 mm 20-lead PQFN package. The MMIC design is configured as a pair of cascode PHEMT amplifiers for broadband performance. It is designed for integration in a 75-ohm push-pull, low distortion, amplifier circuit. The device is ideally suited for use in CATV, DBS, and HDTV applications where low noise figure and low distortion are required.

Functional Schematic



Ordering Information ¹

Part Number	Package
MAAMSS0003	Bulk Packaging
MAAMSS0003TR	1000 piece reel
MAAMSS0003SMB	Sample Test Board (Includes 5 Samples)

1. Reference Application Note M513 for reel size information.

Absolute Maximum Ratings ^{2,3}

Parameter	Absolute Maximum
Input Power	+20 dBm
Operating Voltage	+10 volts
Operating Temperature	-40°C to +85°C
Storage Temperature	-65°C to +150°C

- Exceeding any one or combination of these limits may cause permanent damage to this device.
- M/A-COM does not recommend sustained operation near these survivability limits.

Pin Configuration ⁴

PIN No.	PIN Name	Description
1	N/C	No Connection
2	N/C	No Connection
3	FB1	Feedback 1
4	N/C	No Connection
5	N/C	No Connection
6	RI1	RF Input 1
7	N/C	No Connection
8	N/C	No Connection
9	N/C	No Connection
10	RI2	RF Input 2
11	N/C	No Connection
12	N/C	No Connection
13	FB2	Feedback 2
14	N/C	No Connection
15	N/C	No Connection
16	RO2	RF Output 2
17	N/C	No Connection
18	N/C	No Connection
19	N/C	No Connection
20	RO1	RF Output 1

4. The exposed pad centered on the package bottom must be connected to RF and DC ground.

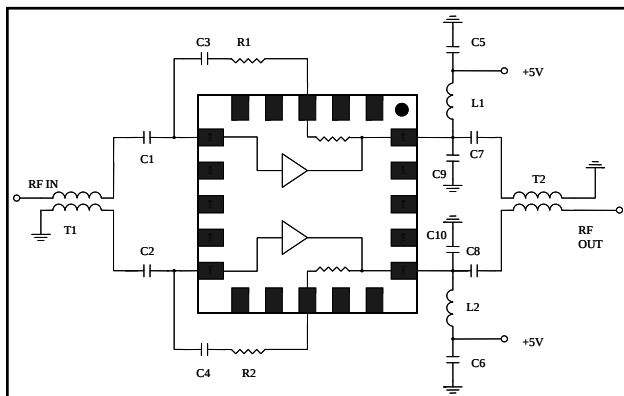
Low Noise CATV Amplifier 50 - 1000 MHz

Rev. V3

Electrical Specifications: $T_A = 25^\circ\text{C}$, Freq: 50 - 1000 MHz, $V_{DD} = +5$ Volts, $Z_0 = 75$ ohms
Test Circuit with M/A-COM Balun ETN1-1-13TR

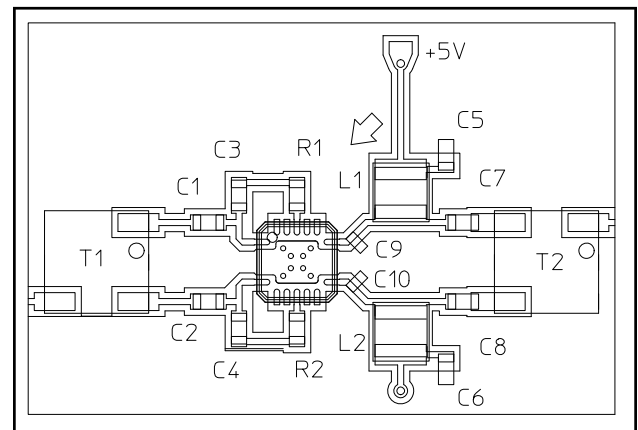
Parameter	Test Conditions	Units	Min.	Typ.	Max.
Gain	—	dB	11.5	12.2	13.0
Gain Flatness	—	dB	—	0.4	1.0
Noise Figure	—	dB	—	3.3	4.0
Input VSWR	—	ratio	—	1.3:1	—
Output VSWR	—	ratio	—	1.5:1	—
Output IP3	Two tones at 397 & 403 MHz, +4 dBm output per tone	dBm	—	32	—
Composite Triple Beat, CTB	135 Channels, +13 dBmV/Channel at the input	dBc	—	-78	-70
Composite Second Order, CSO	135 Channels, +13 dBmV/Channel at the input	dBc	—	-78	-70
Cross modulation	135 Channels, +13 dBmV/Channel at the input	dBc	—	-73	-64
P1dB	400 MHz	dBm	—	24	—
I_{DD}	+5 Volts	mA	160	190	225

Test Circuit Schematic⁵



5. The 1:1 baluns, T1 & T2, are M/A-COM part number ETN1-1-13TR.

Recommended Test Circuit Layout⁶



6. Reference M/A-COM Application Note S2083 for recommended PCB configuration. R1 and R2 are 0 ohms.

External Circuitry Parts List

Qty	Description
8	Capacitor, 0.01 uF, 0603, SMT, 10% (C1-C8)
2	Capacitor, 2 pF, 0402, SMT, $\pm 0.25\text{pF}$ (C9-C10)
2	Inductor, 390 nH, 1008, SMT, 10% (L1, L2)
2	Balun, 1:1, M/A-COM, ETN1-1-13, SMT (T1, T2)
2	Resistor, 0 ohms, 0603, SMT (R1, R2)

Handling Procedures

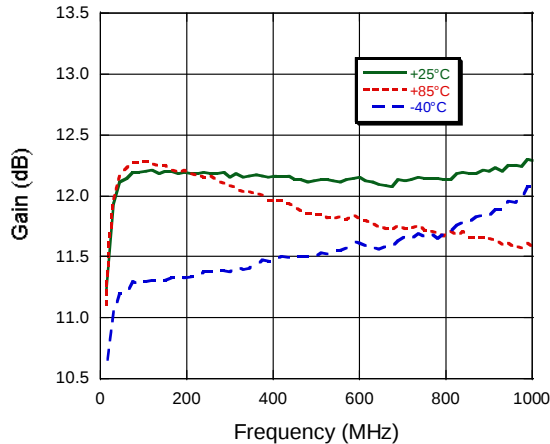
Please observe the following precautions to avoid damage:

Static Sensitivity

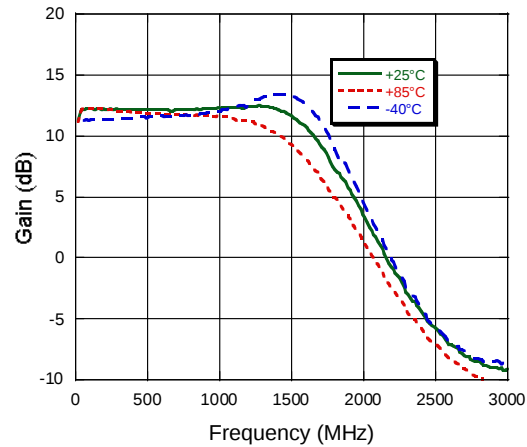
Gallium Arsenide Integrated Circuits are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these devices.

Typical Performance Curves

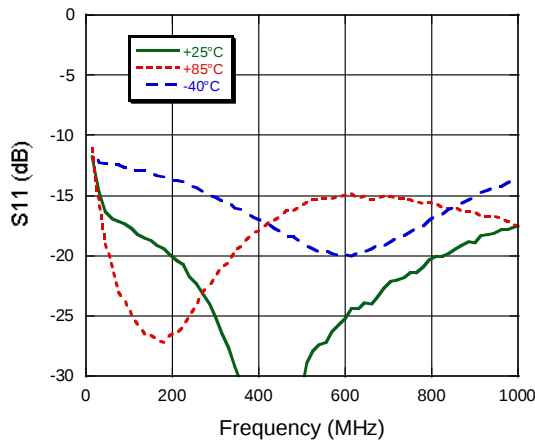
Gain



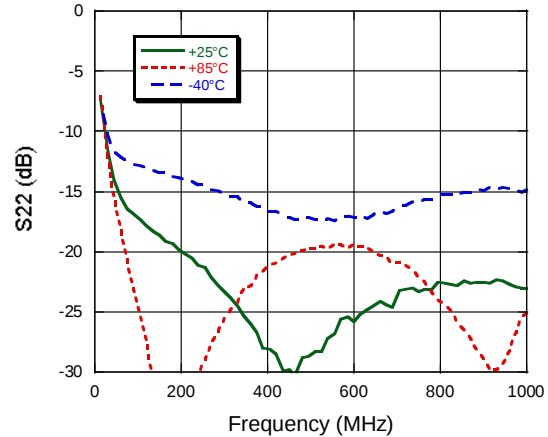
Gain vs. Frequency to 3 GHz



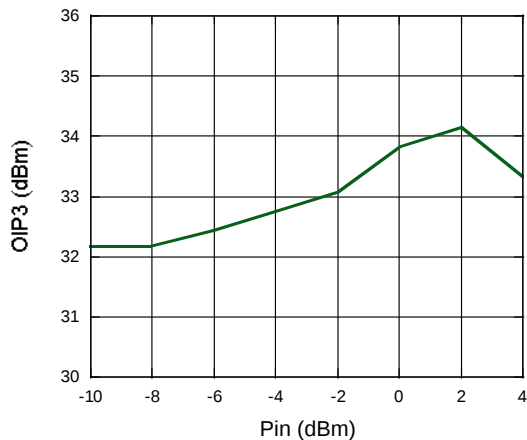
Input Return Loss



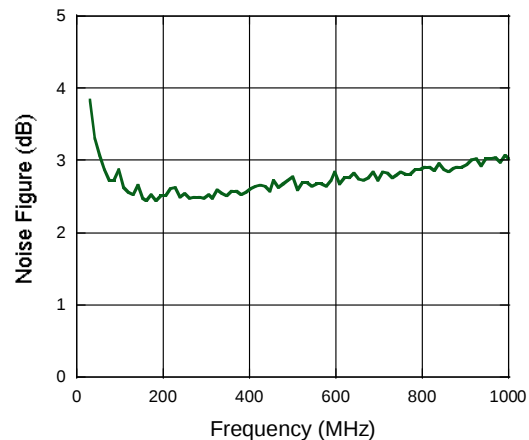
Output Return Loss



OIP3 vs. P_{IN} at 400 MHz, 25°C

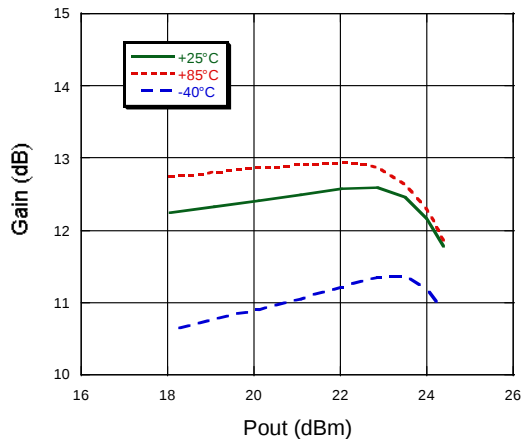


Noise Figure vs. Frequency, 25°C



Rev. V3

Gain vs P_{OUT} at 400 MHz



The drawing illustrates the mechanical specifications of the V66D-1 integrated circuit package. It includes three views: top, side, and bottom.

- Top View:** Shows a square package with a width of 0.1575 ± 0.004 inches. The pin 1 identifier is located at the top left. The package contains a date code, part number, and lot number. The pin 1 identifier is marked with a circle containing a plus sign.
- Side View:** Shows the package height and the location of the seating plate. The total height is 0.079 ± 0.020 inches. The seating plate is located at a height of 0.0020 ± 0.0000 inches from the bottom.
- Bottom View:** Shows the package footprint and the location of the exposed pad. The package width is 0.1575 ± 0.004 inches. The pin 1 identifier is located at the bottom left. The package contains a date code, part number, and lot number. The pin 1 identifier is marked with a circle containing a plus sign. The package is mounted on a PCB with a 0.0846 ± 0.0039 inch gap between the package and the PCB. The package is mounted on a PCB with a 0.0079 ± 0.020 inch gap between the package and the PCB. The package is mounted on a PCB with a 0.0079 ± 0.020 inch gap between the package and the PCB.

NOTES: 1. REFERENCE JEDEC MO-220. VAR. V66D-1 FOR ADDITIONAL DIMENSIONAL AND TOLERANCE INFORMATION.
2. REFERENCE S2083 APPLICATION NOTE FOR PCB FOOTPRINT INFORMATION.
3. ALL DIMENSIONS SHOWN AS INCHES/MM.

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



Тел: +7 (812) 336 43 04 (многоканальный)

Email: org@lifeelectronics.ru

www.lifeelectronics.ru